

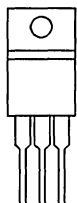
N-Channel Enhancement-Mode Transistor

175°C Maximum Junction Temperature

Product Summary

$V_{(BR)DSS}$ (V)	$r_{DS(on)}$ (Ω)	I_D (A)
60	0.014	60 ^a

TO-220AB



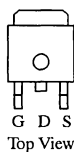
G D S

Top View

SUP60N06-14

DRAIN connected to TAB

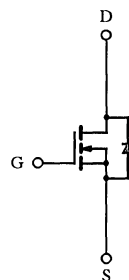
TO-263



G D S

Top View

SUB60N06-14



N-Channel MOSFET

Absolute Maximum Ratings ($T_C = 25^\circ\text{C}$ Unless Otherwise Noted)

Parameter		Symbol	Limit	Unit
Gate-Source Voltage		V_{GS}	± 20	V
Continuous Drain Current ($T_J = 175^\circ\text{C}$)	$T_C = 25^\circ\text{C}$	I_D	60 ^a	A
	$T_C = 100^\circ\text{C}$		42	
Pulsed Drain Current		I_{DM}	240	
Avalanche Current		I_{AR}	60	
Repetitive Avalanche Energy ^b		E_{AR}	180	mJ
Power Dissipation	$T_C = 25^\circ\text{C}$ (TO-220AB and TO-263)	P_D	100	W
	$T_A = 25^\circ\text{C}$ (TO-263) ^c		3.7	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-55 to 175	$^\circ\text{C}$

Thermal Resistance Ratings

Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount (TO-263) ^c	R_{thJA}	40	$^\circ\text{C/W}$
	Free Air (TO-220AB)		80	
Junction-to-Case		R_{thJC}	1.5	

Notes:

- Package limited.
- Duty cycle $\leq 1\%$.
- When mounted on 1" square PCB (FR-4 material).

(05/16/94)

Specifications (T_J = 25°C Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA	60			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _{DS} = 1 mA	2.0	3.0	4.0	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ±20 V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 48 V, V _{GS} = 0 V			25	μA
		V _{DS} = 48 V, V _{GS} = 0 V, T _J = 125°C			250	
		V _{DS} = 48 V, V _{GS} = 0 V, T _J = 175°C			500	
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	60			A
Drain-Source On-State Resistance ^b	r _{DS(on)}	V _{GS} = 10 V, I _D = 30 A			0.014	Ω
		V _{GS} = 10 V, I _D = 30 A, T _J = 125°C			0.023	
		V _{GS} = 10 V, I _D = 30 A, T _J = 175°C			0.028	
Forward Transconductance ^b	g _{fs}	V _{DS} = 15 V, I _D = 30 A		TBD		S
Dynamic ^a						
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		TBD		pF
Output Capacitance	C _{oss}			TBD		
Reversen Transfer Capacitance	C _{rss}			TBD		
Total Gate Charge ^c	Q _g	V _{DS} = 30 V, V _{GS} = 10 V, I _D = 60 A		TBD	130	nC
Gate-Source Charge ^c	Q _{gs}			TBD		
Gate-Drain Charge ^c	Q _{gd}			TBD		
Turn-On Delay Time ^c	t _{d(on)}	V _{DD} = 30 V, R _L = 0.47 Ω I _D = 60 A, V _{GEN} = 10 V, R _G = 2.5 Ω		TBD	30	ns
Rise Time ^c	t _r			TBD	180	
Turn-Off Delay Time ^c	t _{d(off)}			TBD	100	
Fall Time ^c	t _f			TBD	50	
Source-Drain Diode Ratings and Characteristics (T _C = 25°C) ^a						
Continuous Current	I _S				60	A
Pulsed Current	I _{SM}				240	
Forward Voltage ^b	V _{SD}	I _F = 60 A, V _{GS} = 0 V			1.8	V
Reverse Recovery Time	t _{rr}	I _F = 60 A, di/dt = 100 A/μs		TBD		ns
Peak Reverse Recovery Current	I _{RM(REC)}			TBD		A
Reverse Recovery Charge	Q _{rr}			TBD		μC

Notes:

- Guaranteed by design, not subject to production testing.
- Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
- Independent of operating temperature.